

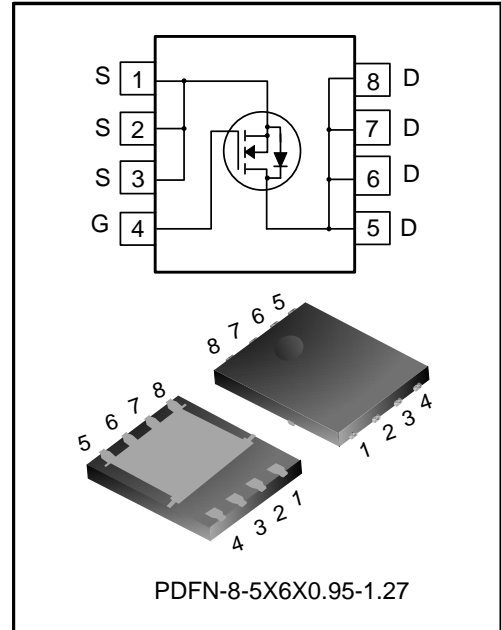
140A, 60V N-CHANNEL MOSFET

DESCRIPTION

SVG062R8NL5 is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance and high avalanche breakdown tolerance. This device is widely used in power management for UPS and Inverter Systems.

FEATURES

- ◆ 140A, 60V, $R_{DS(on)(typ.)}=2.4m\Omega@V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low C_{rss}
- ◆ Fast switching
- ◆ Extreme dv/dt rated
- ◆ 100% avalanche tested
- ◆ Pb-free lead plating
- ◆ RoHS compliant



KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V_{DS}	60	V
$V_{GS(th)}$	2.5~3.5	V
$R_{DS(on),max}$	2.8	$m\Omega$
I_D	140	A
$Q_{g,typ}$	48	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVG062R8NL5TR	PDFN-8-5X6X0.95-1.27	062R8NL5	Halogen free	Tape & Reel

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, T_J=25°C)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Voltage	V _{DS}	--	60	--	--	V
Gate-source Voltage	V _{GS}	--	-20	--	20	V
Drain Current (Note 1)	I _D	T _C =25°C	--	--	140	A
		T _C =100°C	--	--	88	
Drain Current Pulsed (Note 2)	I _{DM}	T _C =25°C	--	--	560	A
Power Dissipation (Note 3)	P _D	T _C =25°C	--	--	109	W
Single Pulsed Avalanche Energy	E _{AS}	L=0.1mH, V _{DD} =48V, R _G =25Ω, starting temperature T _J =25°C	--	--	180	mJ
Single Pulsed Current	I _{AS}	--	--	--	60	A
Operation Junction Temperature Range	T _J	--	-55	--	150	°C
Storage Temperature Range	T _{stg}	--	-55	--	150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	R _{θJC}	--	--	--	1.15	°C/W
Thermal Resistance, Junction-ambient	R _{θJA}	--	--	--	50	°C/W
Soldering Temperature(SMD)	T _{sold}	Reflow soldering:10±1sec, 3times	--	--	260	°C

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, T_J=25°C)
Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	60	--	--	V
Drain-source Leakage Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V, T _J =25°C	--	--	1.0	μA
		V _{DS} =60V, V _{GS} =0V, T _J =125°C	--	3.0	--	μA
Gate-source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250μA	2.5	--	3.5	V
Static Drain-source On State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =15A	--	2.4	2.8	mΩ
Gate Resistance	R _g	f=1MHz	--	1.6	--	Ω

Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{iss}	$f=1\text{MHz}, V_{GS}=0\text{V}, V_{DS}=30\text{V}$	--	3115	--	pF
Output Capacitance	C_{oss}		--	742	--	
Reverse Transfer Capacitance	C_{rss}		--	27	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=30\text{V}, V_{GS}=10\text{V}, R_G=4.7\Omega, I_D=15\text{A}$ (Notes 4, 5)	--	20	--	ns
Turn-on Rise Time	t_r		--	35	--	
Turn-off Delay Time	$t_{d(off)}$		--	42	--	
Turn-off Fall Time	t_f		--	13	--	
Total Gate Charge	Q_g	$V_{DD}=30\text{V}, V_{GS}=10\text{V}, I_D=30\text{A}$ (Notes 4, 5)	--	48	--	nC
Gate-source Charge	Q_{gs}		--	17	--	
Gate-drain Charge	Q_{gd}		--	10	--	
Gate-plateau Voltage	$V_{plateau}$		--	5.3	--	V

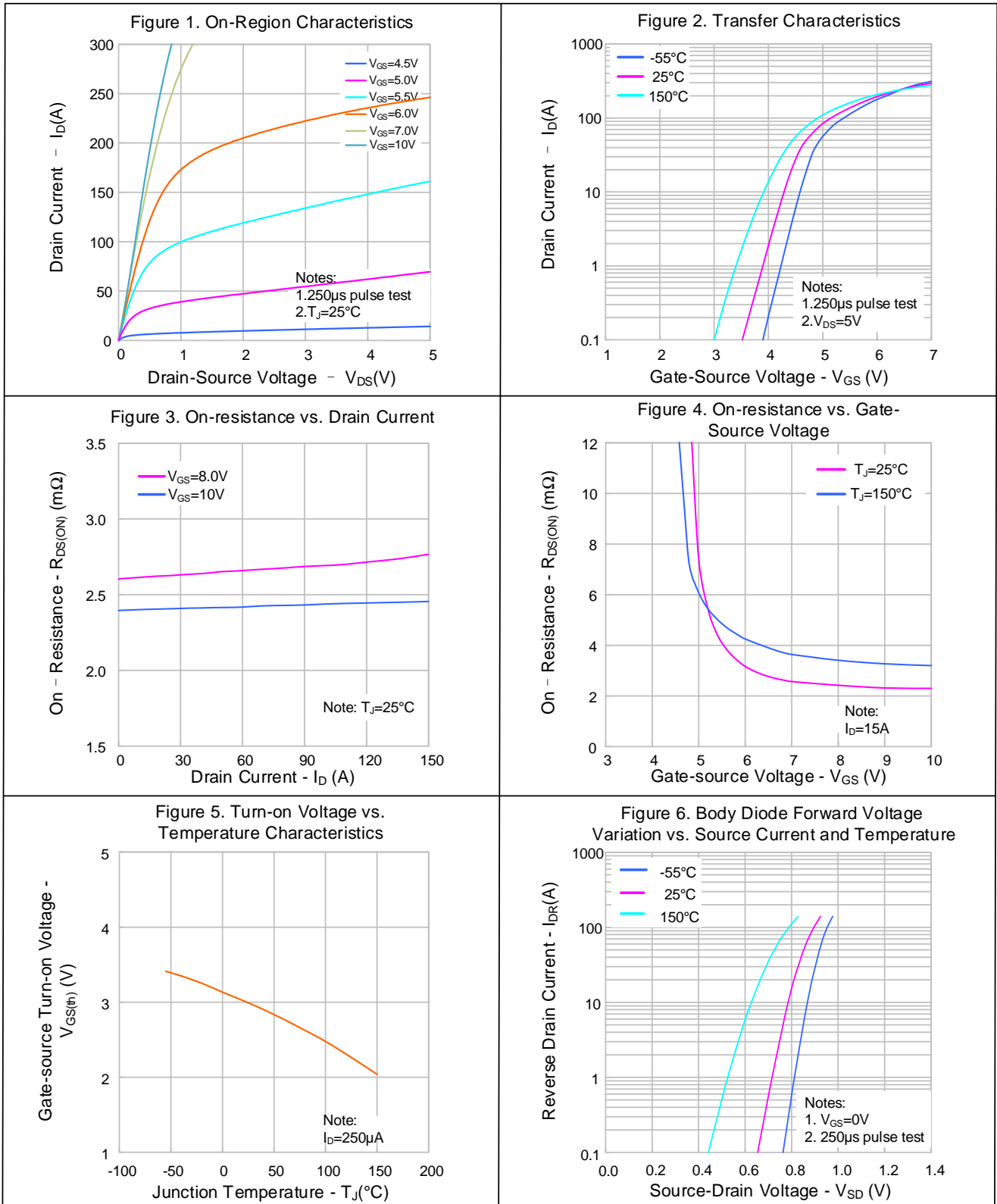
Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Continuous Diode Forward Current	I_S	Integral reverse P-N junction diode in the MOSFET	--	--	140	A
Diode Pulse Current	$I_{S,pulse}$		--	--	560	
Diode Forward Voltage	V_{SD}	$I_S=30\text{A}, V_{GS}=0\text{V}$	--	--	1.2	V
Reverse Recovery Time	T_{rr}	$I_S=30\text{A}, V_{GS}=0\text{V}, V_R=48\text{V}$ $dl_F/dt=100\text{A}/\mu\text{s}$ (Note 4)	--	50	--	ns
Reverse Recovery Charge	Q_{rr}		--	76	--	nC

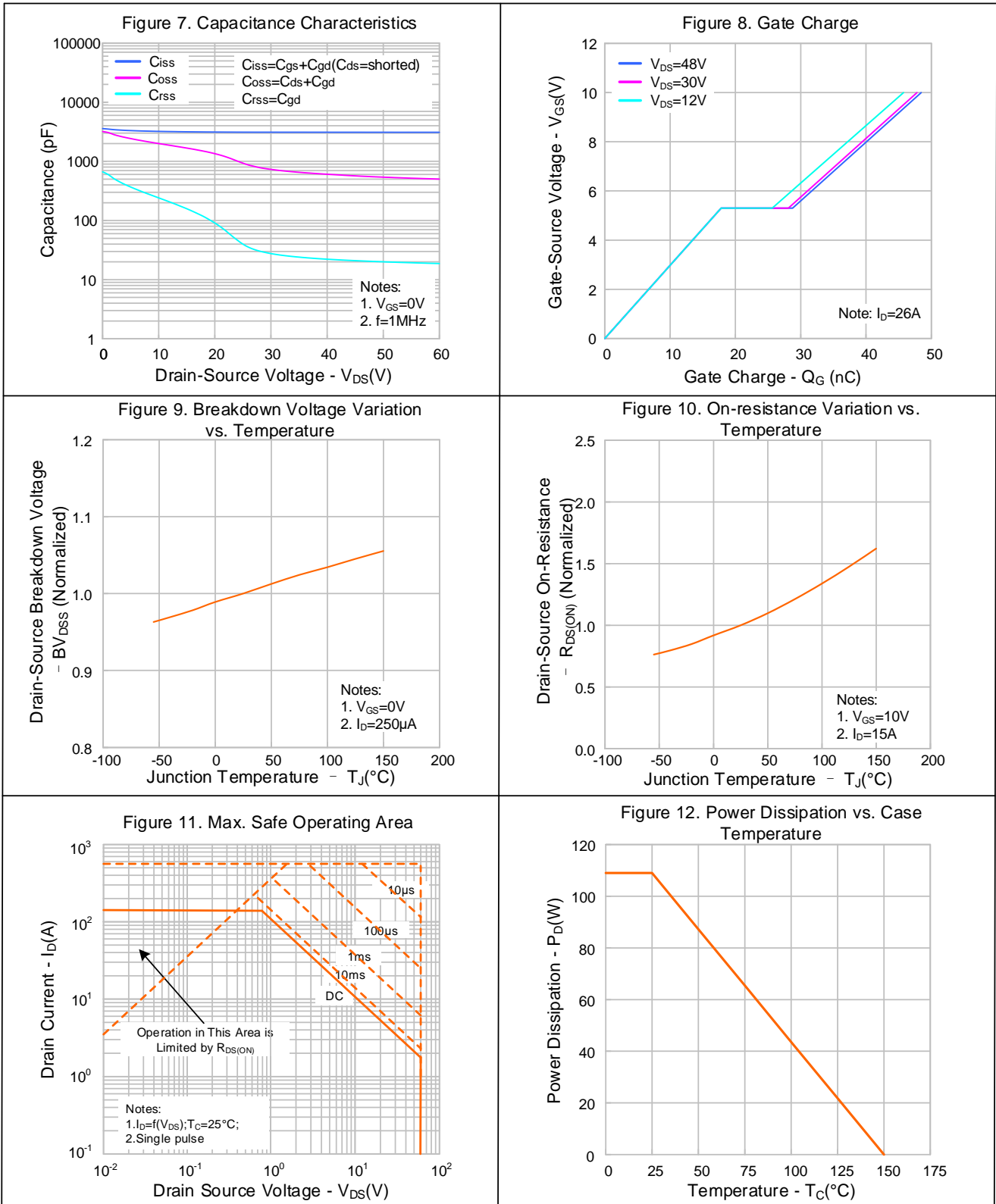
Notes:

- The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C, it should be derated according to the actual environmental conditions;
- Pulse time 5μs, pulse width is limited by the maximum junction temperature;
- The dissipation power will change with temperature, derating above 25°C: 0.87W/°C;
- Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
- Essentially independent of operating temperature.

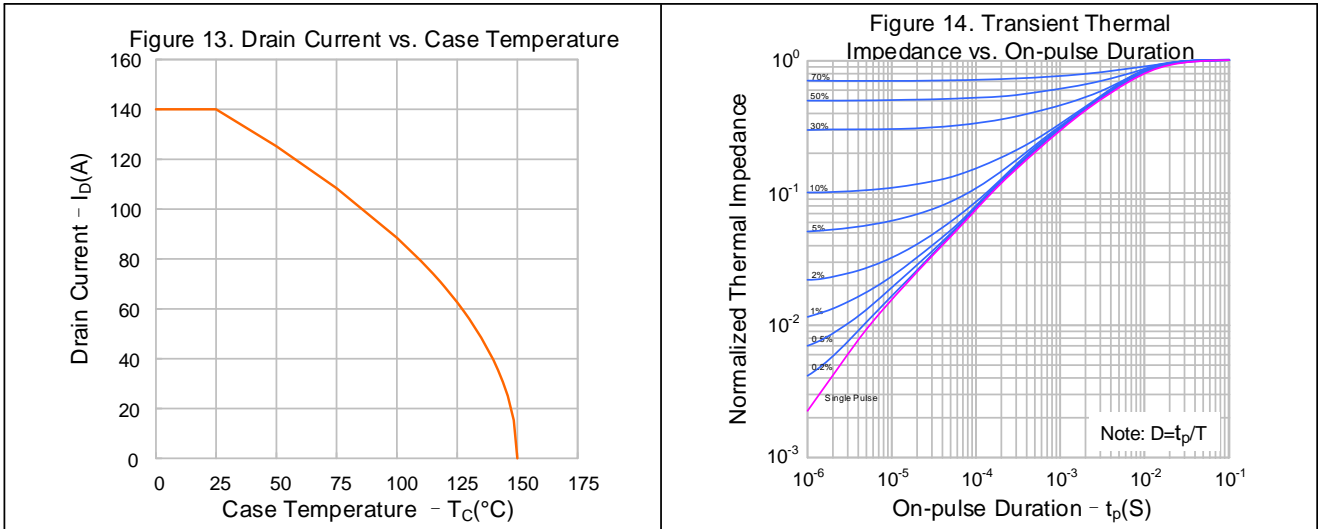
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)

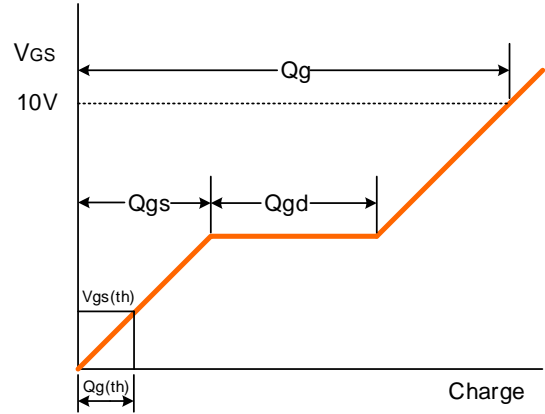
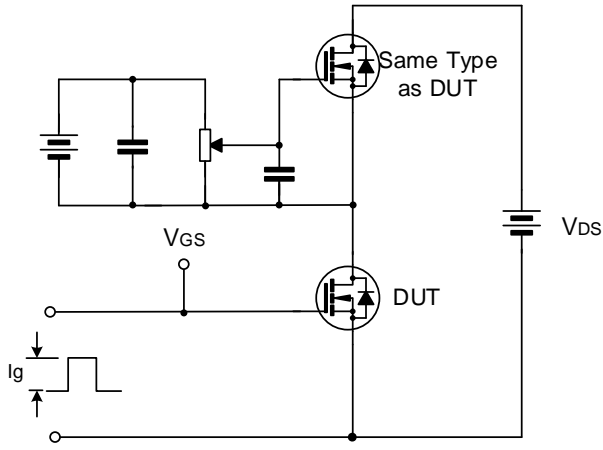


TYPICAL CHARACTERISTICS (CONTINUED)

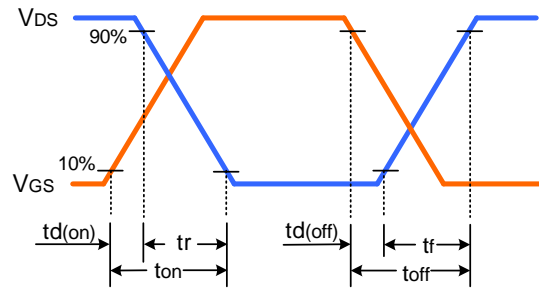
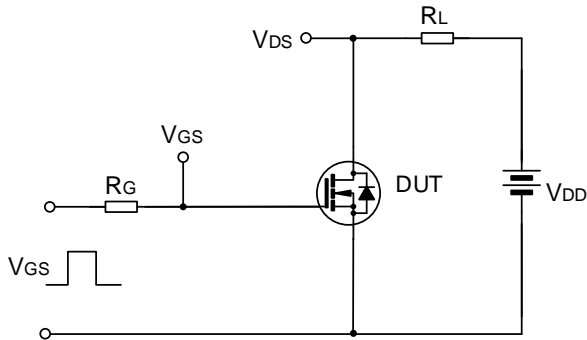


TYPICAL TEST CIRCUIT

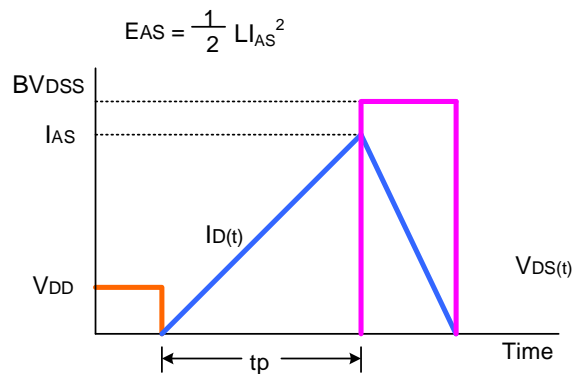
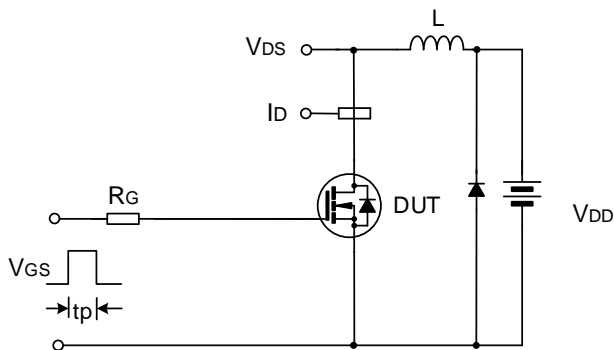
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



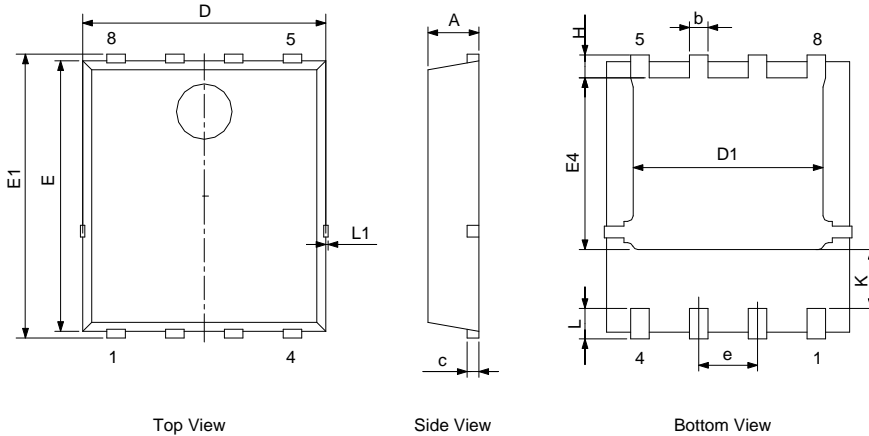
Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE

PDFN-8-5X6X0.95-1.27

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.90	—	1.20
c	0.154	0.25	0.354
D	4.80	—	5.40
E	5.66	—	6.06
D1	3.76	—	4.30
E1	5.90	—	6.35
b	0.30	—	0.55
K	1.10	1.30	1.50
e	1.07	1.27	1.37
E4	3.34	—	3.92
L	0.30	0.60	0.71
L1	—	—	0.12
H	0.40	—	0.71



MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

Important notice:

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Rev.: **1.1**

Revision History:

1. Delete wave soldering condition
 2. Update the typical test circuit
 3. Update the important notice
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Rev.: **1.0**

Revision History:

1. First release
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